



ESA ESTEC
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The Netherlands

LT1009_TID_TEST_REPORT

LT1009IDR

Date Code: 1125

2.5V Bandgap Voltage Reference

Texas Instruments

LT1009S8#TRPBF

Date Code: 2029

2.5V Bandgap Voltage Reference

Analog Devices

Prepared by

Florian Krimmel

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1. INTRODUCTION

The current report presents the TID results on the Bandgap Voltage Reference LT1009

- LT1009IDR, date code: 1125, Texas Instruments
- LT1009S8#TRPBF, date code: 2029, Analog Devices

The test campaign was performed between the 24th January and 18th February 2022 at the ESTEC 60Co facility.

Additional information on the context is provided in the test plan [RD01].

2. DOCUMENTS

2.1. Applicable documents

AD01 ESCC22900 Total Dose Steady-state irradiation test method, June 2016

2.2. Reference documents

RD01 TID_COTS_Bandgap-ref_test_plan

RD02 RA0005344 Radiation Test Summary

3. PART & PROCUREMENT INFORMATION

| | | |
|------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Part number | LT1009IDR | LT1009S8#TRPBF |
| Manufacturer | Texas Instruments | Analog Devices |
| Function | 2.5V Bandgap Voltage Reference | 2.5V Bandgap Voltage Reference |
| Technology | Bipolar | Bipolar |
| Package | <p>D OR PW PACKAGE (TOP VIEW)</p> | <p>TOP VIEW</p> <p>S8 PACKAGE 8-LEAD PLASTIC SO</p> <p>$T_{JMAX} = 150^\circ\text{C}$, $\theta_{JA} = 190^\circ\text{C/W}$</p> |
| Date Code [yyww] | 1125 | 2029 |
| Distributor | Farnell | Mouser |
| Part # (sample n°) date code | 5 samples unbiased (n° B90 to B94) 5 samples biased (n° B95 to B99) 1 reference unbiased (n° REF19) 1 reference biased (n° REF69) | 5 samples unbiased (n° C00 to C04) 5 samples biased (n° C05 to C09) 1 reference unbiased (n° REF20) 1 reference biased (n° REF70) |

Table 1: Part & procurement information

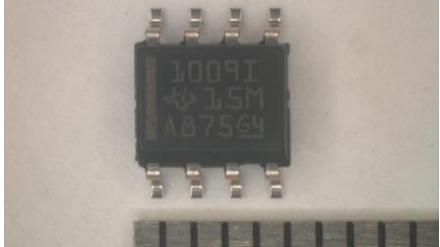
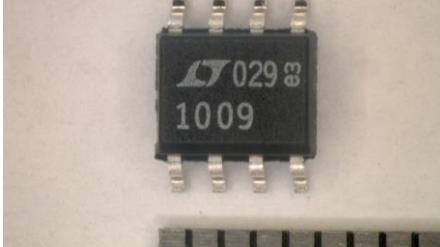
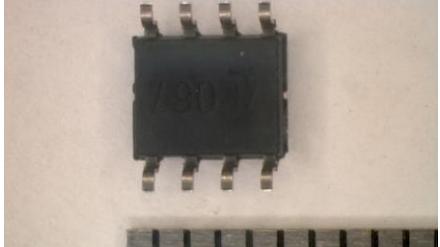
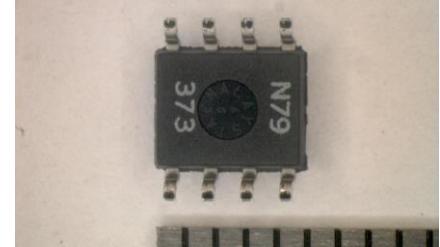
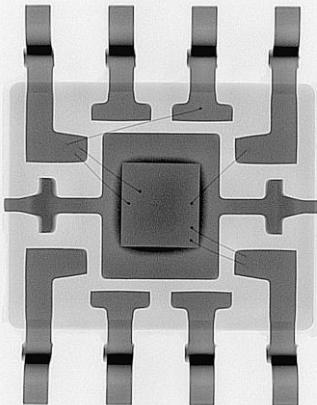
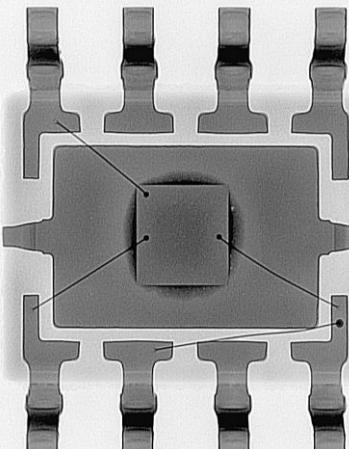
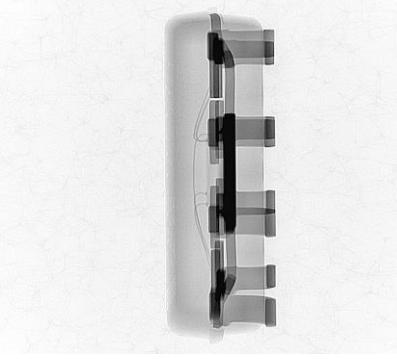
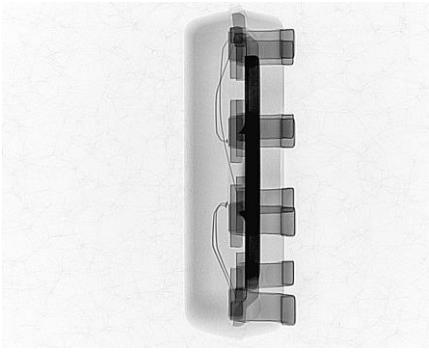
| Part number | LT1009IDR | LT1009S8#TRPBF |
|------------------------|-------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------|
| Package marking top |  |  |
| Package marking bottom |  |  |
| X-ray top view |  |  |
| X-ray side view |  |  |

Table 2: Package marking X-ray of the DUT

4. DOSIMETRY AND IRRADIATION FACILITY

IRRADIATION FACILITY

Source: C060

Localization: ESTEC, Netherlands

Dosimetry: Electrometer: Farmer model 2670 – s/n 491

Ionisation chamber: PTW TW30012-10 s/n 000417

IRRADIATION TIMING

| | |
|-----------------------|---------------------------------------|
| TID steps (krad(Si)) | 0, 5, 10, 15, 20, 38.2, 50, 80.5, 100 |
| Dose rate (rad(Si)/h) | 240 - 260 |

| | |
|---------------------|----------------------------------------------------------------------|
| ANNEALING TIMING | Condition during annealing |
| Annealing 22°C 24 h | Biased for those tested biased Unbiased for those tested unbiased |
| Ageing 100°C 168h | ON for those tested ON Unbiased for those tested unbiased |

Values are provided in TID(H₂O), the conversion to TID(Si) is done using the conversion factor of: 0.898.

5. TEST SET-UP

5.1. Test set-up overview

The set-up to measure at specific TID steps outside the irradiation chamber is schematically depicted in the Figure 1. Inside the radiation chamber the component boards with the DUTs on it are connected to the biasing boards which have a determined resistor to create the right value of biasing current (typical current acc. to datasheet) from a 12V supply for each biased component. Additionally to that, there are also 0-Ohm resistors on the biasing boards to connect all pins of the unbiased components.

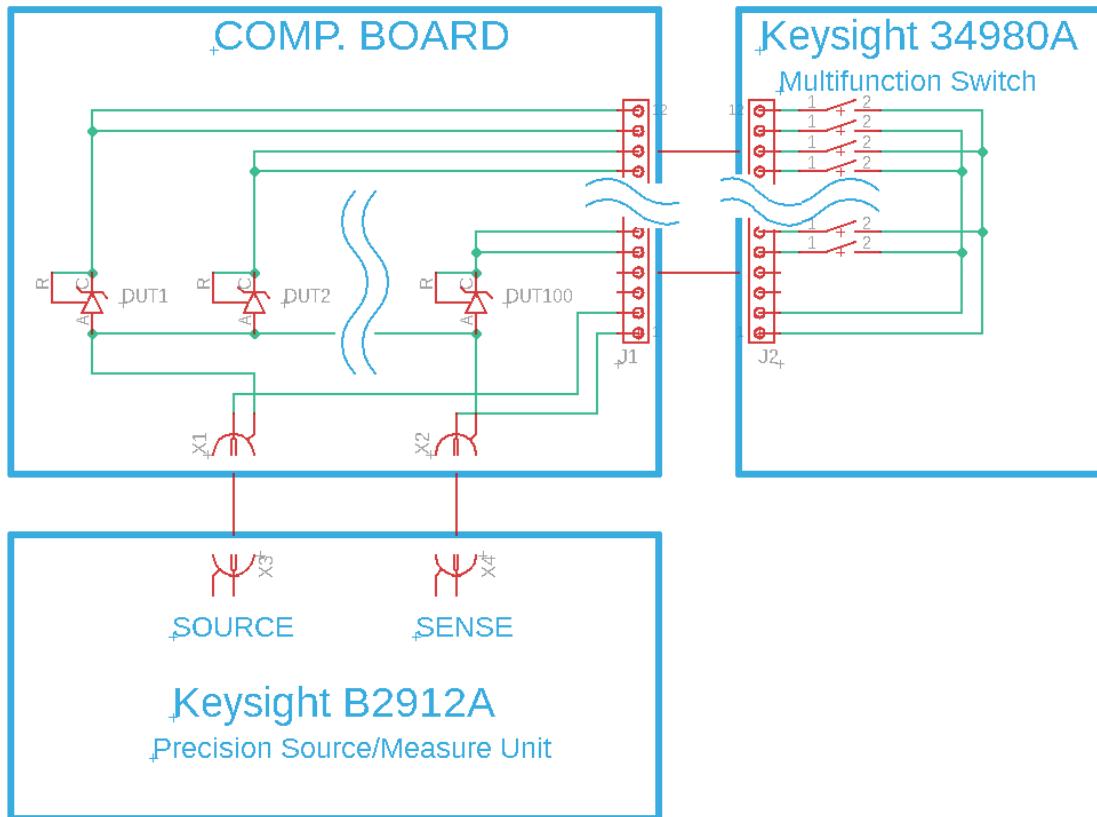


Figure 1: Simplified schematic of the overall test set-up

Four PCBs which were specially designed for this purpose could allow to accommodate both biased and unbiased components for this component and also other bandgap reference components at the same time on a $12 \times 22 \text{ cm}^2$ PCB. This size of the boards limits the TID variation across board to less than 10%. Set-up pictures are provided in Annex B.

During each defined TID step a PC laptop was used to acquire the voltage (V_z) as well as the input current (I_z) of each of the samples from the source measure unit (SMU). The laptop time is synchronised to the time used for controlling the Co60 facility.

5.2. Test equipment

TEST EQUIPMENT

1 x Keysight B2912A 2412A Precision Source/Measure Unit (SMU)

PARAMETER MEASURED

Providing 6 different I_Z currents acc. to datasheet of the components:

I_{min} , $0.8 \times I_{typ}$, I_{typ} , $3.14 \times I_{typ}$, $10 \times I_{typ}$, I_{max}

$V_{max} = 5.0 \text{ V}$

1 x Keysight 34980A Multifunction Switch

Switching through all up to 100 samples solder on one board.

1 x Laptop with LabView

Logging and saving the V_Z and I_Z measurements using an in-house VI.

6. TEST PARAMETERS

The following two parameters are measured:

| PARAMETERS | SYMBOLS |
|---------------------------|---------|
| Reverse Breakdown Voltage | V_Z |
| Reverse Current | I_Z |

7. BIASING CONDITIONS

All biased samples are continuously biased with the typical value of I_Z according to the datasheet of each part type:

Table summarised the main biasing conditions

| PART TYPE | Value | Unit |
|----------------|-------|------|
| LT1009IDR | 1 | mA |
| LT1009S8#TRPBF | 1 | mA |

Table 2: Biasing conditions during irradiation

8. TID RESULTS

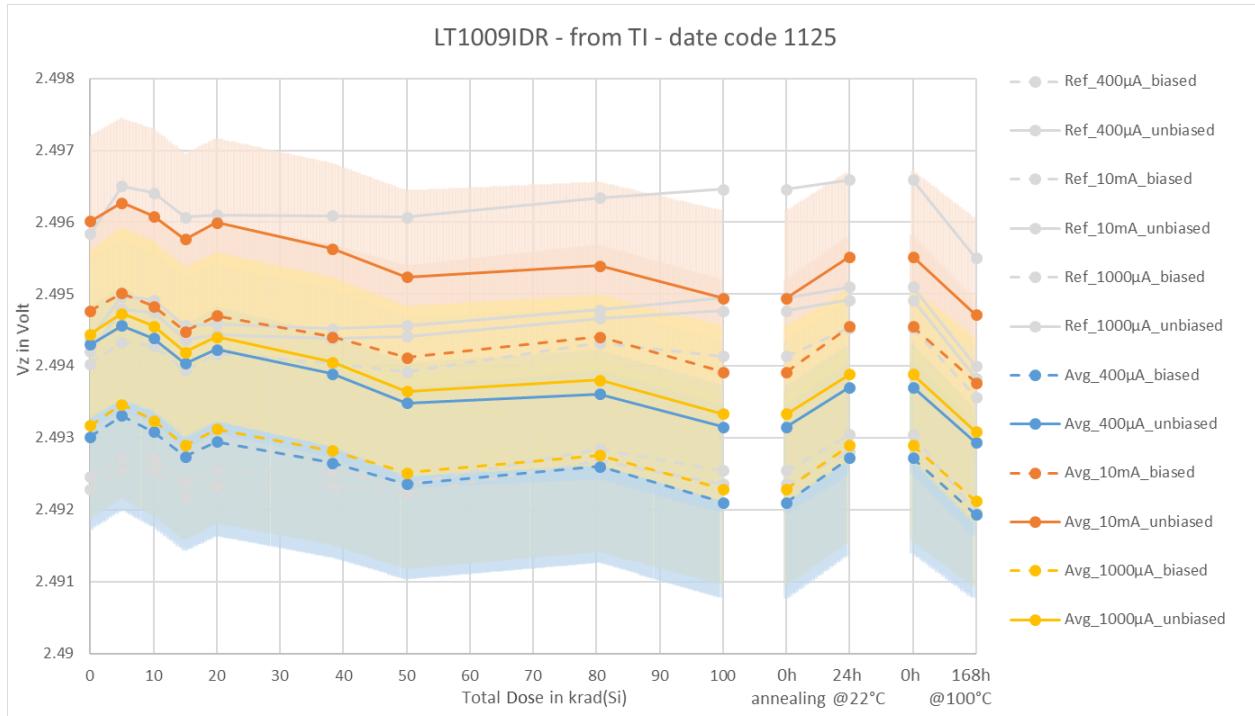
8.1. TID RESULTS - LT1009IDR - from TI - date code 1125

| LT1009IDR - from TI - date code 1125 - @ I-min 400µA | | | | | | | | | | | | |
|------------------------------------------------------|--------------|--------|--------|--------|--------|--------|--------|--------|--------|--------|----------------------|-----------------|
| DUT No. | krad (Si) | 0 | 5 | 10 | 15 | 20 | 38.2 | 50 | 80.5 | 100 | Room Temp. annealing | 100°C annealing |
| B90 | unbiased | 2.4943 | 2.4946 | 2.4944 | 2.4941 | 2.4943 | 2.4939 | 2.4934 | 2.4936 | 2.4931 | 2.4936 | 2.4926 |
| B91 | | 2.4951 | 2.4953 | 2.4951 | 2.4948 | 2.4950 | 2.4946 | 2.4943 | 2.4944 | 2.4940 | 2.4945 | 2.4940 |
| B92 | | 2.4933 | 2.4935 | 2.4934 | 2.4930 | 2.4932 | 2.4929 | 2.4925 | 2.4927 | 2.4922 | 2.4928 | 2.4919 |
| B93 | | 2.4958 | 2.4961 | 2.4959 | 2.4956 | 2.4957 | 2.4954 | 2.4950 | 2.4952 | 2.4947 | 2.4953 | 2.4947 |
| B94 | | 2.4930 | 2.4933 | 2.4931 | 2.4927 | 2.4929 | 2.4926 | 2.4922 | 2.4923 | 2.4918 | 2.4924 | 2.4916 |
| B95 | biased | 2.4930 | 2.4933 | 2.4931 | 2.4927 | 2.4930 | 2.4926 | 2.4923 | 2.4925 | 2.4921 | 2.4927 | 2.4922 |
| B96 | | 2.4950 | 2.4953 | 2.4951 | 2.4948 | 2.4950 | 2.4947 | 2.4944 | 2.4947 | 2.4942 | 2.4948 | 2.4938 |
| B97 | | 2.4915 | 2.4917 | 2.4915 | 2.4911 | 2.4913 | 2.4911 | 2.4908 | 2.4910 | 2.4905 | 2.4911 | 2.4907 |
| B98 | | 2.4932 | 2.4934 | 2.4932 | 2.4929 | 2.4931 | 2.4927 | 2.4925 | 2.4928 | 2.4922 | 2.4929 | 2.4919 |
| B99 | | 2.4925 | 2.4928 | 2.4925 | 2.4922 | 2.4924 | 2.4921 | 2.4918 | 2.4921 | 2.4916 | 2.4922 | 2.4911 |
| REF19 | Ref unbiased | 2.4942 | 2.4948 | 2.4948 | 2.4944 | 2.4944 | 2.4944 | 2.4944 | 2.4947 | 2.4948 | 2.4949 | 2.4938 |
| REF69 | Ref biased | 2.4923 | 2.4926 | 2.4926 | 2.4922 | 2.4923 | 2.4923 | 2.4922 | 2.4927 | 2.4924 | 2.4928 | 2.4918 |

| LT1009IDR - from TI - date code 1125 - @ I-typ 1000µA | | | | | | | | | | | | |
|-------------------------------------------------------|--------------|--------|--------|--------|--------|--------|--------|--------|--------|--------|----------------------|-----------------|
| Limit acc. DS: Vz = 2.5V ± 1% (2.475V – 2.525V) | | | | | | | | | | | | |
| DUT No. | krad (Si) | 0 | 5 | 10 | 15 | 20 | 38.2 | 50 | 80.5 | 100 | Room Temp. annealing | 100°C annealing |
| B90 | unbiased | 2.4945 | 2.4948 | 2.4946 | 2.4942 | 2.4944 | 2.4941 | 2.4936 | 2.4937 | 2.4932 | 2.4937 | 2.4927 |
| B91 | | 2.4952 | 2.4955 | 2.4953 | 2.4949 | 2.4952 | 2.4948 | 2.4944 | 2.4946 | 2.4941 | 2.4947 | 2.4941 |
| B92 | | 2.4934 | 2.4937 | 2.4936 | 2.4932 | 2.4934 | 2.4931 | 2.4927 | 2.4929 | 2.4924 | 2.4930 | 2.4921 |
| B93 | | 2.4960 | 2.4963 | 2.4961 | 2.4957 | 2.4959 | 2.4956 | 2.4952 | 2.4953 | 2.4949 | 2.4955 | 2.4948 |
| B94 | | 2.4932 | 2.4935 | 2.4933 | 2.4929 | 2.4931 | 2.4928 | 2.4924 | 2.4925 | 2.4920 | 2.4925 | 2.4918 |
| B95 | biased | 2.4932 | 2.4934 | 2.4933 | 2.4929 | 2.4931 | 2.4928 | 2.4925 | 2.4927 | 2.4923 | 2.4929 | 2.4924 |
| B96 | | 2.4952 | 2.4955 | 2.4952 | 2.4949 | 2.4951 | 2.4948 | 2.4946 | 2.4948 | 2.4944 | 2.4950 | 2.4940 |
| B97 | | 2.4917 | 2.4919 | 2.4916 | 2.4913 | 2.4915 | 2.4912 | 2.4909 | 2.4911 | 2.4907 | 2.4913 | 2.4909 |
| B98 | | 2.4933 | 2.4936 | 2.4934 | 2.4930 | 2.4933 | 2.4929 | 2.4927 | 2.4929 | 2.4924 | 2.4930 | 2.4921 |
| B99 | | 2.4926 | 2.4929 | 2.4927 | 2.4924 | 2.4926 | 2.4923 | 2.4919 | 2.4922 | 2.4918 | 2.4924 | 2.4913 |
| REF19 | Ref unbiased | 2.4944 | 2.4950 | 2.4949 | 2.4946 | 2.4946 | 2.4945 | 2.4946 | 2.4948 | 2.4950 | 2.4951 | 2.4940 |
| REF69 | Ref biased | 2.4925 | 2.4927 | 2.4927 | 2.4924 | 2.4926 | 2.4925 | 2.4924 | 2.4929 | 2.4926 | 2.4931 | 2.4920 |

LT1009IDR - from TI - date code 1125 - @ I-max 10mA

| DUT No. | krad (Si) | 0 | 5 | 10 | 15 | 20 | 38.2 | 50 | 80.5 | 100 | Room Temp. annealing | 100°C annealing |
|---------|--------------|--------|--------|--------|--------|--------|--------|--------|--------|--------|----------------------|-----------------|
| B90 | unbiased | 2.4961 | 2.4963 | 2.4962 | 2.4958 | 2.4961 | 2.4956 | 2.4952 | 2.4954 | 2.4949 | 2.4954 | 2.4944 |
| | | 2.4968 | 2.4971 | 2.4969 | 2.4966 | 2.4968 | 2.4964 | 2.4960 | 2.4962 | 2.4958 | 2.4963 | 2.4958 |
| | | 2.4949 | 2.4952 | 2.4950 | 2.4947 | 2.4950 | 2.4946 | 2.4942 | 2.4944 | 2.4940 | 2.4946 | 2.4936 |
| | | 2.4975 | 2.4978 | 2.4976 | 2.4973 | 2.4975 | 2.4971 | 2.4968 | 2.4969 | 2.4965 | 2.4971 | 2.4964 |
| | | 2.4948 | 2.4950 | 2.4948 | 2.4945 | 2.4947 | 2.4943 | 2.4939 | 2.4941 | 2.4936 | 2.4942 | 2.4934 |
| B95 | biased | 2.4948 | 2.4950 | 2.4949 | 2.4945 | 2.4947 | 2.4944 | 2.4941 | 2.4944 | 2.4939 | 2.4945 | 2.4941 |
| B96 | | 2.4967 | 2.4969 | 2.4968 | 2.4964 | 2.4966 | 2.4964 | 2.4961 | 2.4964 | 2.4959 | 2.4965 | 2.4955 |
| B97 | | 2.4933 | 2.4935 | 2.4933 | 2.4929 | 2.4931 | 2.4928 | 2.4926 | 2.4928 | 2.4924 | 2.4930 | 2.4926 |
| B98 | | 2.4949 | 2.4952 | 2.4950 | 2.4946 | 2.4949 | 2.4946 | 2.4942 | 2.4945 | 2.4941 | 2.4947 | 2.4937 |
| B99 | | 2.4943 | 2.4945 | 2.4943 | 2.4940 | 2.4942 | 2.4939 | 2.4936 | 2.4939 | 2.4934 | 2.4940 | 2.4929 |
| REF19 | Ref unbiased | 2.4958 | 2.4965 | 2.4964 | 2.4961 | 2.4961 | 2.4961 | 2.4961 | 2.4963 | 2.4965 | 2.4966 | 2.4955 |
| REF69 | Ref biased | 2.4940 | 2.4943 | 2.4943 | 2.4939 | 2.4942 | 2.4940 | 2.4939 | 2.4943 | 2.4941 | 2.4945 | 2.4936 |



For all curves, which show an average over all measured samples, the coloured interval behind the curves represent +/- one standard deviation.

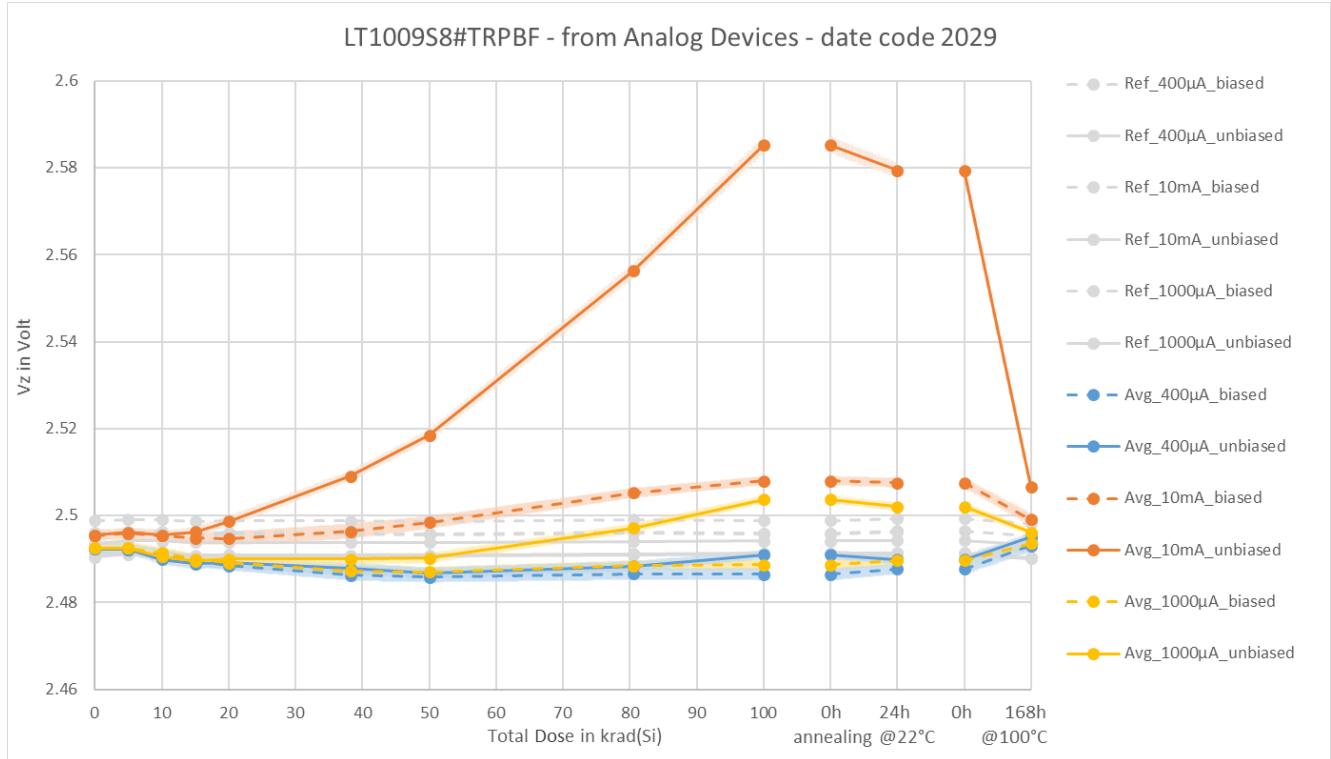
8.2. TID RESULTS - LT1009S8#TRPBF - from Analog Devices - date code 2029

| LT1009S8#TRPBF - from Analog Devices - date code 2029 - @ I-min 400µA | | | | | | | | | | | | |
|-----------------------------------------------------------------------|--------------|--------|--------|--------|--------|--------|--------|--------|--------|--------|----------------------|-----------------|
| DUT No. | krad (Si) | 0 | 5 | 10 | 15 | 20 | 38.2 | 50 | 80.5 | 100 | Room Temp. annealing | 100°C annealing |
| C0 | unbiased | 2.4917 | 2.4911 | 2.4883 | 2.4870 | 2.4874 | 2.4858 | 2.4847 | 2.4867 | 2.4895 | 2.4884 | 2.4943 |
| C1 | | 2.4937 | 2.4935 | 2.4913 | 2.4902 | 2.4906 | 2.4893 | 2.4882 | 2.4898 | 2.4923 | 2.4913 | 2.4964 |
| C2 | | 2.4924 | 2.4924 | 2.4900 | 2.4886 | 2.4888 | 2.4878 | 2.4870 | 2.4887 | 2.4913 | 2.4901 | 2.4949 |
| C3 | | 2.4923 | 2.4921 | 2.4899 | 2.4891 | 2.4896 | 2.4881 | 2.4869 | 2.4884 | 2.4910 | 2.4899 | 2.4948 |
| C4 | | 2.4916 | 2.4918 | 2.4899 | 2.4896 | 2.4899 | 2.4882 | 2.4870 | 2.4883 | 2.4910 | 2.4898 | 2.4949 |
| C5 | biased | 2.4917 | 2.4919 | 2.4909 | 2.4897 | 2.4888 | 2.4863 | 2.4854 | 2.4859 | 2.4857 | 2.4870 | 2.4926 |
| C6 | | 2.4908 | 2.4909 | 2.4896 | 2.4885 | 2.4878 | 2.4869 | 2.4872 | 2.4880 | 2.4875 | 2.4882 | 2.4921 |
| C7 | | 2.4916 | 2.4915 | 2.4905 | 2.4893 | 2.4885 | 2.4863 | 2.4851 | 2.4848 | 2.4846 | 2.4861 | 2.4919 |
| C8 | | 2.4934 | 2.4930 | 2.4912 | 2.4889 | 2.4873 | 2.4844 | 2.4845 | 2.4866 | 2.4868 | 2.4879 | 2.4935 |
| C9 | | 2.4940 | 2.4940 | 2.4928 | 2.4913 | 2.4901 | 2.4874 | 2.4868 | 2.4877 | 2.4879 | 2.4891 | 2.4952 |
| REF20 | Ref unbiased | 2.4905 | 2.4911 | 2.4910 | 2.4906 | 2.4907 | 2.4907 | 2.4907 | 2.4910 | 2.4912 | 2.4912 | 2.4901 |
| REF70 | Ref biased | 2.4957 | 2.4961 | 2.4961 | 2.4956 | 2.4959 | 2.4957 | 2.4956 | 2.4961 | 2.4958 | 2.4962 | 2.4952 |

| LT1009S8#TRPBF - from Analog Devices - date code 2029 - @ I-typ 1000µA | | | | | | | | | | | | |
|------------------------------------------------------------------------|--------------|--------|--------|--------|--------|--------|--------|--------|--------|--------|----------------------|-----------------|
| Limit acc. DS: Vz = 2.5V ± 0.6% (2.485V – 2.515V) | | | | | | | | | | | | |
| DUT No. | krad (Si) | 0 | 5 | 10 | 15 | 20 | 38.2 | 50 | 80.5 | 100 | Room Temp. annealing | 100°C annealing |
| C0 | unbiased | 2.4919 | 2.4916 | 2.4890 | 2.4877 | 2.4882 | 2.4880 | 2.4883 | 2.4955 | 2.5024 | 2.5007 | 2.4955 |
| C1 | | 2.4939 | 2.4939 | 2.4920 | 2.4909 | 2.4914 | 2.4914 | 2.4916 | 2.4983 | 2.5049 | 2.5032 | 2.4974 |
| C2 | | 2.4926 | 2.4927 | 2.4908 | 2.4894 | 2.4897 | 2.4899 | 2.4904 | 2.4971 | 2.5035 | 2.5018 | 2.4960 |
| C3 | | 2.4925 | 2.4925 | 2.4906 | 2.4898 | 2.4904 | 2.4903 | 2.4905 | 2.4973 | 2.5039 | 2.5022 | 2.4959 |
| C4 | | 2.4919 | 2.4921 | 2.4906 | 2.4903 | 2.4906 | 2.4904 | 2.4905 | 2.4972 | 2.5039 | 2.5022 | 2.4959 |
| C5 | biased | 2.4919 | 2.4922 | 2.4914 | 2.4902 | 2.4894 | 2.4873 | 2.4868 | 2.4879 | 2.4881 | 2.4892 | 2.4931 |
| C6 | | 2.4911 | 2.4911 | 2.4899 | 2.4889 | 2.4883 | 2.4877 | 2.4882 | 2.4895 | 2.4894 | 2.4900 | 2.4926 |
| C7 | | 2.4918 | 2.4918 | 2.4909 | 2.4899 | 2.4892 | 2.4874 | 2.4865 | 2.4869 | 2.4870 | 2.4883 | 2.4925 |
| C8 | | 2.4936 | 2.4933 | 2.4916 | 2.4895 | 2.4879 | 2.4854 | 2.4857 | 2.4884 | 2.4889 | 2.4899 | 2.4940 |
| C9 | | 2.4942 | 2.4943 | 2.4933 | 2.4918 | 2.4908 | 2.4885 | 2.4881 | 2.4897 | 2.4901 | 2.4912 | 2.4958 |
| REF20 | Ref unbiased | 2.4908 | 2.4914 | 2.4913 | 2.4909 | 2.4910 | 2.4909 | 2.4909 | 2.4912 | 2.4914 | 2.4915 | 2.4904 |
| REF70 | Ref biased | 2.4960 | 2.4963 | 2.4963 | 2.4958 | 2.4961 | 2.4960 | 2.4959 | 2.4963 | 2.4960 | 2.4965 | 2.4954 |

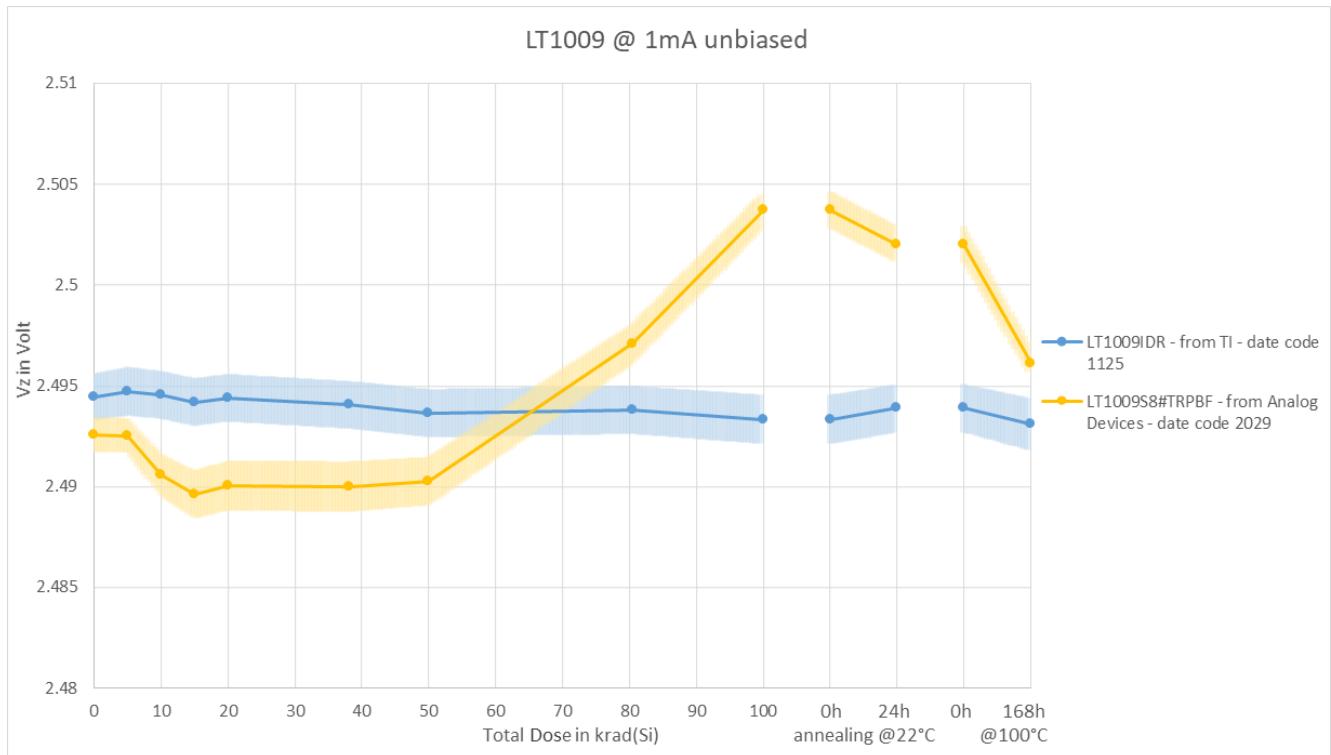
LT1009S8#TRPBF - from Analog Devices - date code 2029 - @ I-max 10mA

| DUT No. | krad (Si) | 0 | 5 | 10 | 15 | 20 | 38.2 | 50 | 80.5 | 100 | Room Temp. annealing | 100°C annealing |
|---------|--------------|--------|--------|--------|--------|--------|--------|--------|--------|--------|-------------------------|--------------------|
| C0 | unbiased | 2.4948 | 2.4951 | 2.4940 | 2.4945 | 2.4970 | 2.5075 | 2.5170 | 2.5555 | 2.5850 | 2.5794 | 2.5062 |
| C1 | | 2.4969 | 2.4975 | 2.4968 | 2.4975 | 2.4999 | 2.5101 | 2.5193 | 2.5568 | 2.5858 | 2.5801 | 2.5080 |
| C2 | | 2.4955 | 2.4962 | 2.4955 | 2.4959 | 2.4981 | 2.5082 | 2.5173 | 2.5539 | 2.5822 | 2.5766 | 2.5065 |
| C3 | | 2.4954 | 2.4961 | 2.4955 | 2.4966 | 2.4992 | 2.5098 | 2.5194 | 2.5576 | 2.5868 | 2.5807 | 2.5064 |
| C4 | | 2.4947 | 2.4957 | 2.4955 | 2.4970 | 2.4994 | 2.5099 | 2.5194 | 2.5574 | 2.5864 | 2.5804 | 2.5063 |
| C5 | biased | 2.4948 | 2.4956 | 2.4955 | 2.4953 | 2.4954 | 2.4972 | 2.4991 | 2.5057 | 2.5083 | 2.5079 | 2.4987 |
| C6 | | 2.4941 | 2.4944 | 2.4934 | 2.4929 | 2.4928 | 2.4948 | 2.4971 | 2.5038 | 2.5066 | 2.5061 | 2.4983 |
| C7 | | 2.4947 | 2.4953 | 2.4951 | 2.4950 | 2.4954 | 2.4977 | 2.4994 | 2.5055 | 2.5081 | 2.5076 | 2.4980 |
| C8 | | 2.4965 | 2.4967 | 2.4956 | 2.4942 | 2.4935 | 2.4943 | 2.4966 | 2.5045 | 2.5077 | 2.5073 | 2.4995 |
| C9 | | 2.4970 | 2.4976 | 2.4973 | 2.4967 | 2.4966 | 2.4979 | 2.4998 | 2.5066 | 2.5094 | 2.5090 | 2.5013 |
| REF20 | Ref unbiased | 2.4937 | 2.4942 | 2.4942 | 2.4938 | 2.4939 | 2.4938 | 2.4938 | 2.4941 | 2.4942 | 2.4943 | 2.4933 |
| REF70 | Ref biased | 2.4989 | 2.4991 | 2.4991 | 2.4987 | 2.4989 | 2.4988 | 2.4987 | 2.4991 | 2.4989 | 2.4993 | 2.4982 |



8.1. Comparison Manufacturer and Date Code

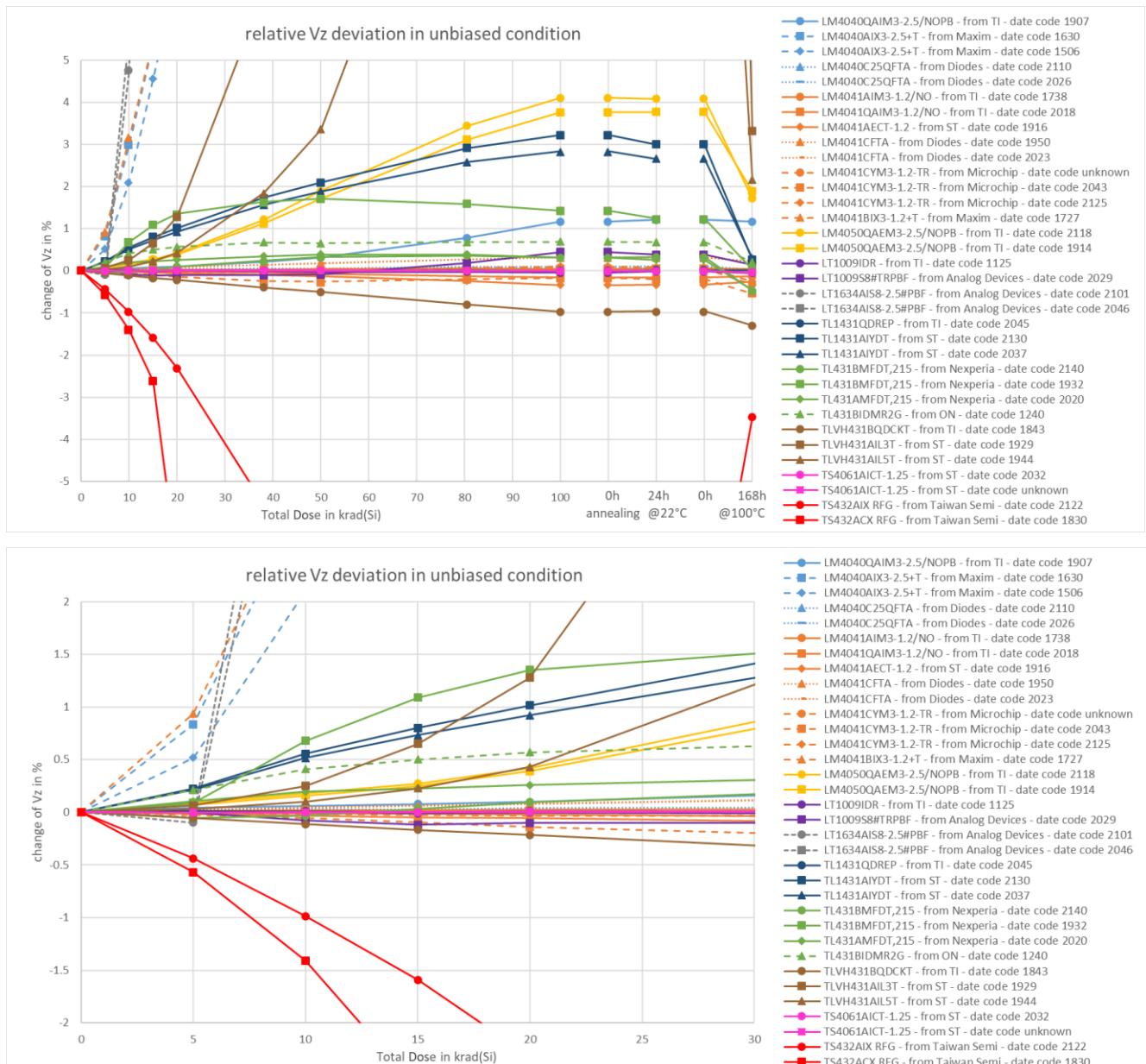
The following graph shows the different behaviour of all measured LT1009 voltage references with different date code.

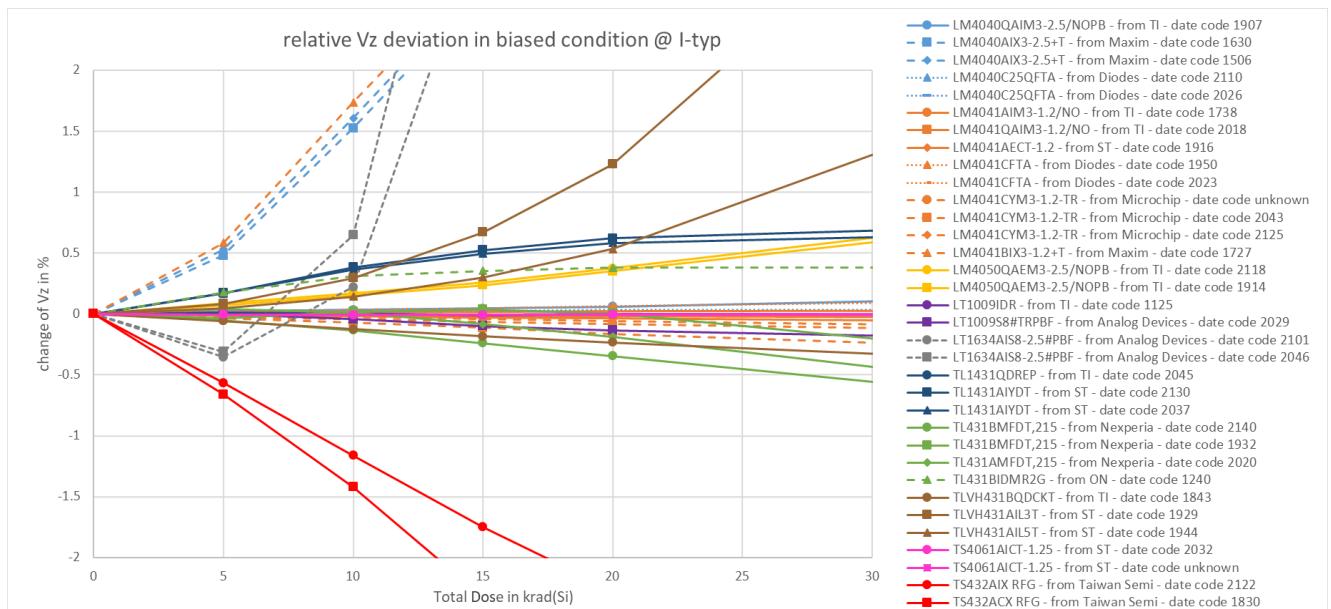
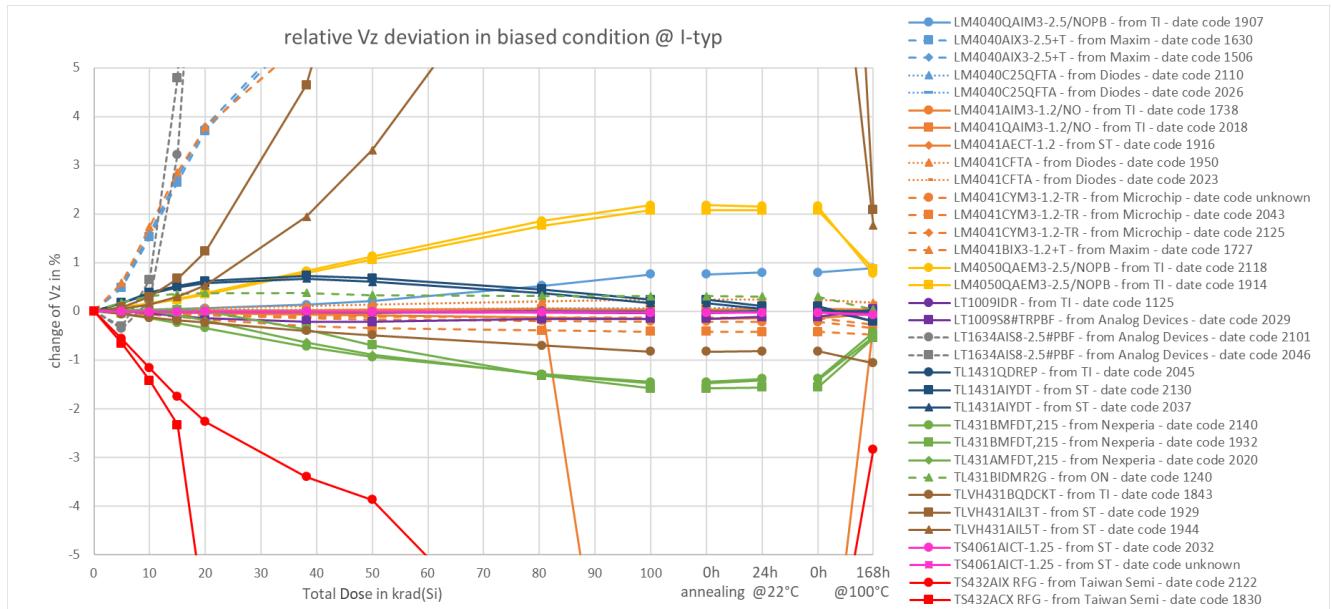


All curves plotted show the average value of all unbiased tested samples (worst case) and the interval behind the curves represent +/- one standard deviation.

8.2. Comparison with other tested Bandgap References

The following four graphs show the results of the LT1009 Bandgap Voltage References compared to different Bandgap References part types, which were tested at the same time with the same test setup than the LT1009. Additional information on these tests is provided in the Radiation Test Summary [RD02].





9. CONCLUSION

Up to the maximal tested dose of 100krad the deviation of all tested samples stayed inside the tolerances according to the datasheet.

The deviation of tested components from the two different manufactures show a significant different behaviour in respect of TID effects.

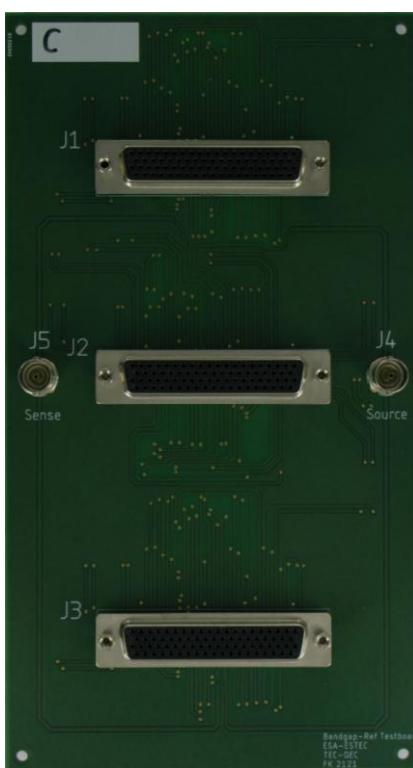
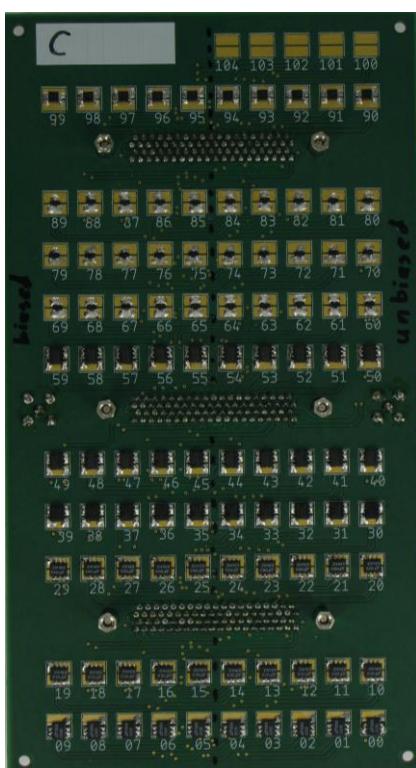
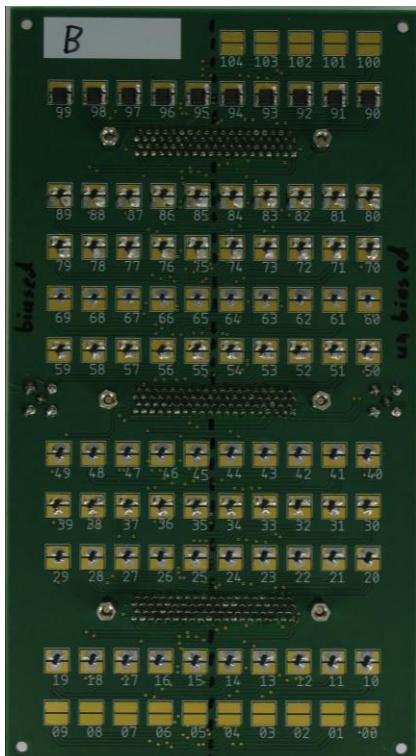
In general, a higher deviation was found for the unbiased samples.

ANNEX A – DATASHEET

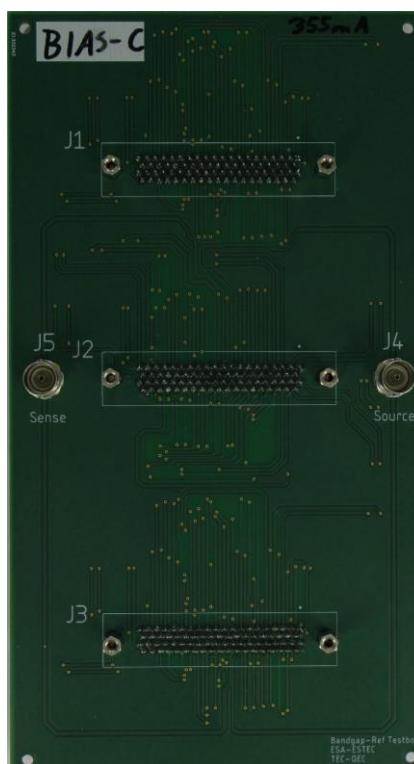
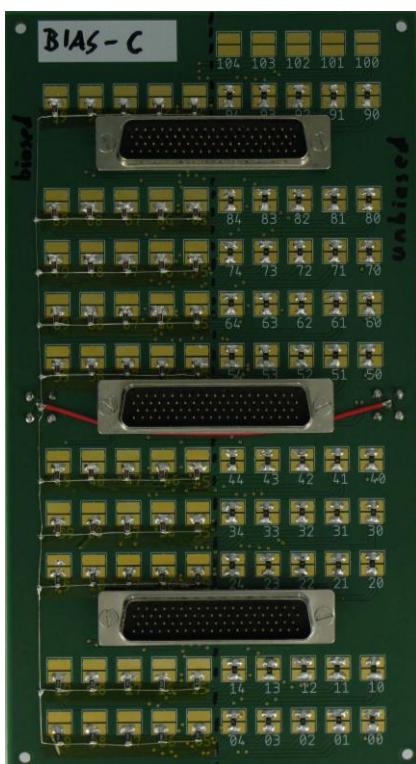
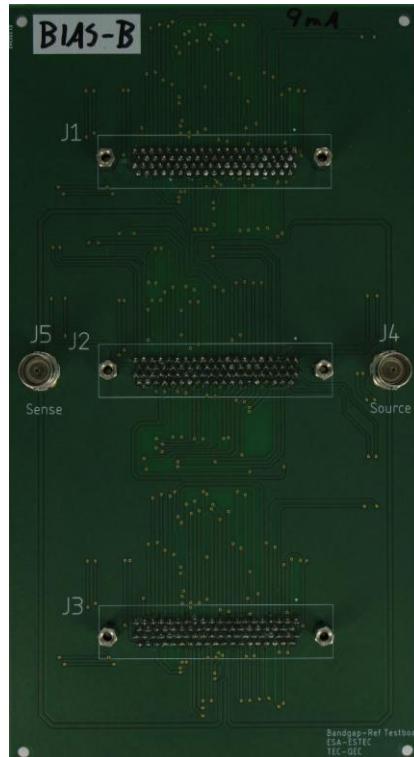
| Part Type | Manufacturer | Link to Datasheet |
|----------------|-------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| LT1009IDR | Texas Instruments | https://www.ti.com/lit/ds/symlink/lt1009.pdf?HQS=dis-dk-null-digikeymode-dsf-pf-null-wwe&ts=1617892474582 |
| LT1009S8#TRPBF | Analog Devices | https://www.analog.com/media/en/technical-documentation/data-sheets/LT1009.pdf |

ANNEX B – SET-UP

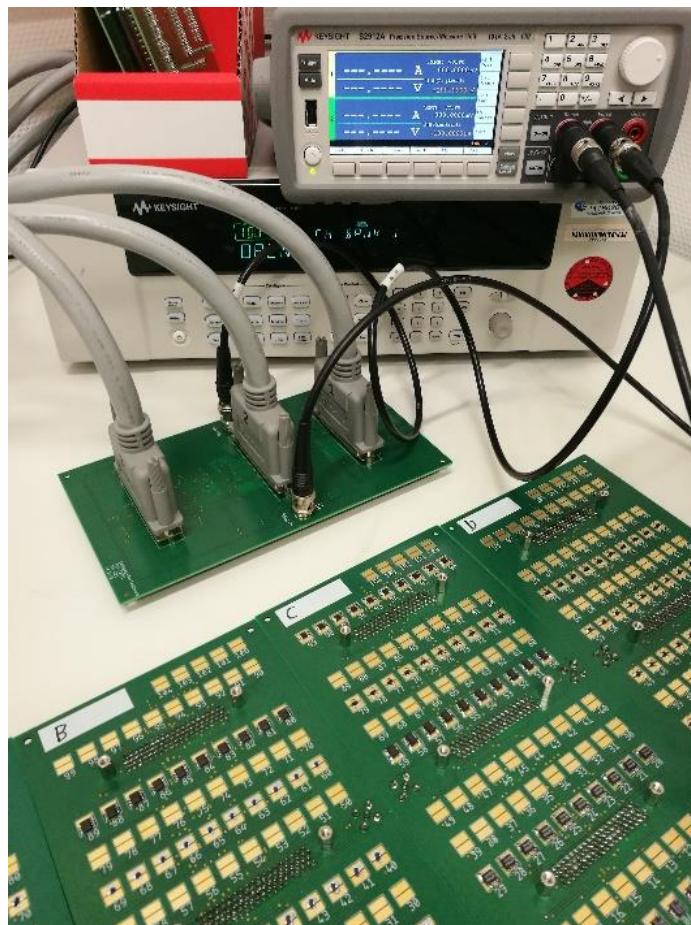
Test board front- and backside with the LT1009 on position 90 to 99 on board B and position 00 to 09 on board C:



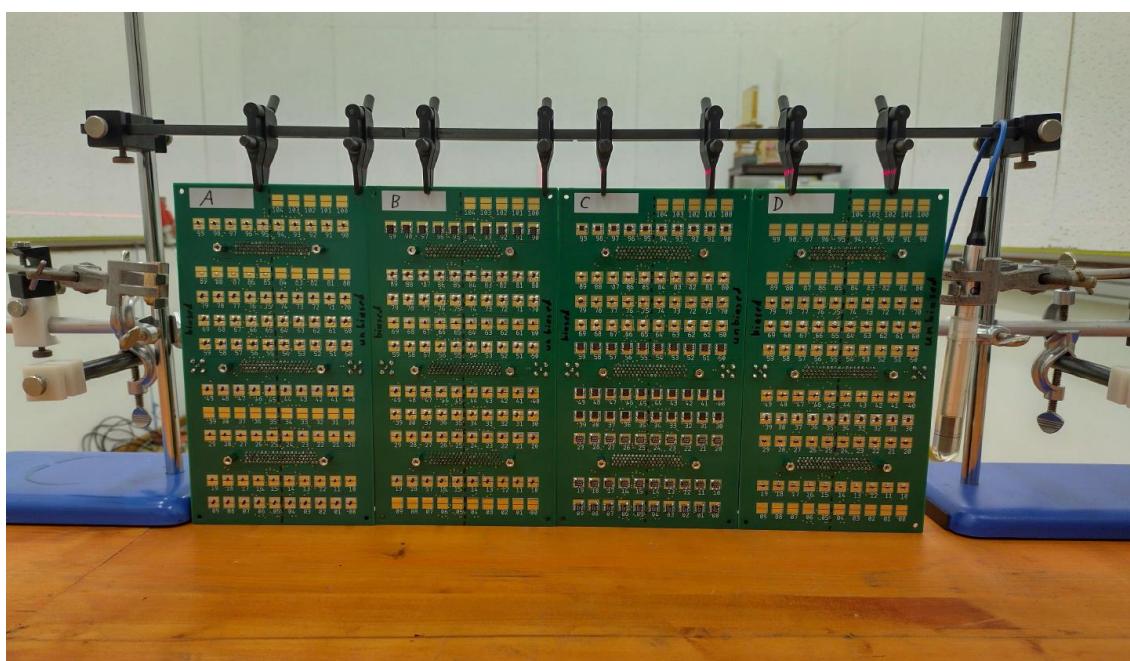
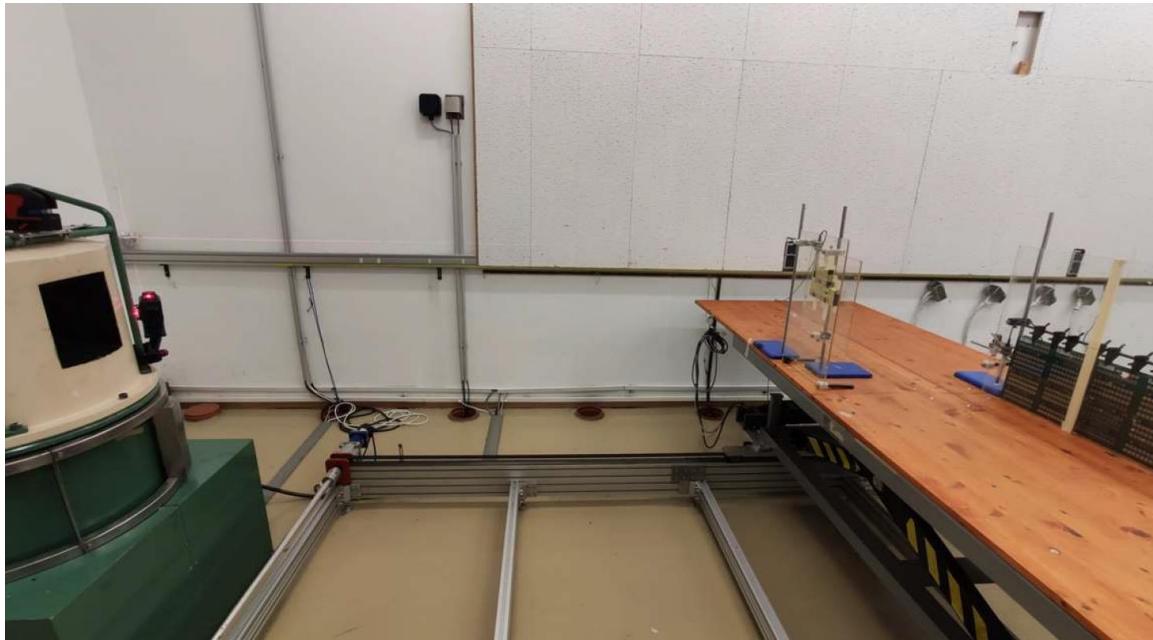
Biasing board front- and backside with the biasing resistors on it:



Measurement setup with the cable connection from the Test Board to the Switching Matrix
and the Source Measure Unit:



Position of the boards inside the Co60 irradiation chamber:



ANNEX C – RADIATION TEST SUMMARY – IRRADIATION STEPS

| Irr. Run | Start Date & Time (CET) | End Date & Time (CET) | Total Ionising Dose (water) | Dose Rate (water) |
|--------------|-------------------------|-----------------------|-----------------------------|-------------------|
| 1 | 24-01-2022 18:11:39 | 25-01-2022 13:37:10 | 55.69 Gy | 2.867 Gy/h |
| 2 | 25-01-2022 15:13:42 | 26-01-2022 11:52:43 | 55.67 Gy | 2.696 Gy/h |
| 3 | 26-01-2022 13:30:18 | 27-01-2022 10:16:45 | 55.68 Gy | 2.680 Gy/h |
| 4 | 27-01-2022 12:11:47 | 28-01-2022 08:55:59 | 55.68 Gy | 2.685 Gy/h |
| 5 | 28-01-2022 10:31:55 | 31-01-2022 09:30:00 | 202.3 Gy | 2.851 Gy/h |
| 6 | 31-01-2022 11:18:44 | 02-02-2022 09:21:12 | 131.8 Gy | 2.863 Gy/h |
| 7 | 02-02-2022 11:05:44 | 07-02-2022 09:55:08 | 339.6 Gy | 2.858 Gy/h |
| 8 | 07-02-2022 11:41:36 | 10-02-2022 15:46:14 | 217.1 Gy | 2.854 Gy/h |
| Total | | | 1.114 kGy | |

Note: The uncertainty budgets (according to TEC-QEC/PR001 section 12) are: 4.2 % ($k=2$) for absorbed dose to water and 4.4% ($k=2$) for absorbed dose rate to water

| | units | Min. | Max. | Time-weighted Average |
|-------------------|-------|-------|--------|-----------------------|
| Temperature | °C | 20.9 | 21.2 | 20.93 |
| Pressure | mbar | 996.6 | 1034.5 | 1019.01 |
| Relative Humidity | % | 47.1 | 54 | 51.45 |

| Dosimeter position relative to ^{60}Co source | | |
|--------------------------------------------------------|----|------|
| X | cm | 36.5 |
| Y | cm | 292 |
| Z | cm | -21 |

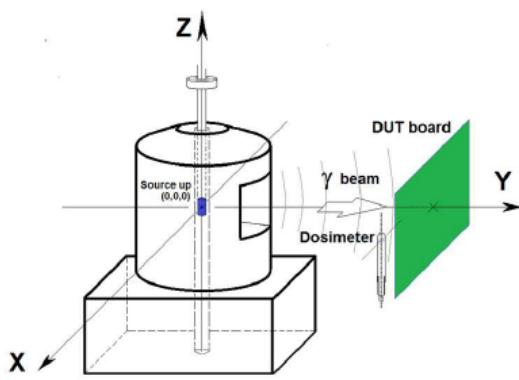


Figure 1 Co-60 irradiator head and board positioning sketch

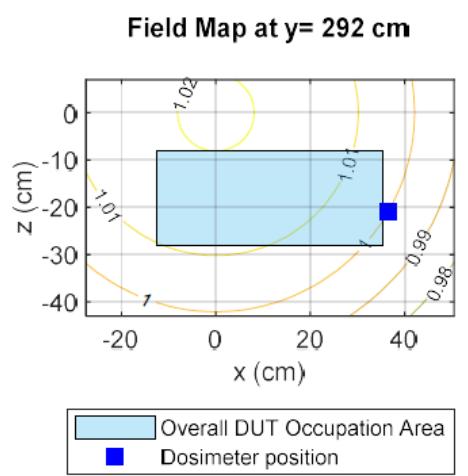


Figure 2: Qualitative indication of dose rate distribution normalized to dosimeter readings. Axes origin located at source centre. Graphs for information only, of the run with highest dose rate.